

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Wing Yiu Yeung	06/14/2010
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Advanced Materials Enterprises Company Limited
<b>Street Address:</b>	Unit 208, IC Development Centre, No. 6 Science Park West Ave.
<b>City:</b>	Shatin, NT
<b>State/Country:</b>	HONG KONG
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12817168
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<b>ATTORNEY DOCKET NUMBER:</b>	AME-1005-USPT
<b>NAME OF SUBMITTER:</b>	Charles Ho
<b>Total Attachments: 1</b> source=Ass_signed-AME-1005-USPT (00003676)#page1.tif	

OP \$40.00 12817168

# ASSIGNMENT - Patent Application

Docket Number: **AME-1005-USPT**

Whereas, the Assignor, comprising the following named inventors:

ASSIGNOR(s)/  
INVENTOR(s)

**YEUNG, Wing Yiu**

made an invention entitled: **Food Baking Machine**

for which an application for Letters Patent of the United States:  
(Select one of the following):

- is executed concurrently herewith  
 was filed in the U.S. Patent and Trademark Office on \_\_\_\_\_,  
as U.S. Patent Application Serial No.: \_\_\_\_\_

ASSIGNEE  
(Full Name, Address and  
Country)

**Advanced Materials Enterprises Company Limited**

**Unit 208, 2/F, IC Development Centre, No. 6 Science Park West Avenue, Hong  
Kong Science Park, Shatin, N.T., Hong Kong**

**Hong Kong, China**

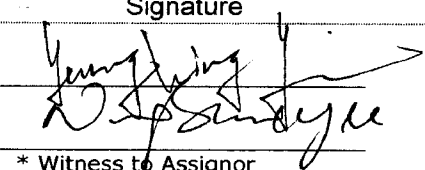
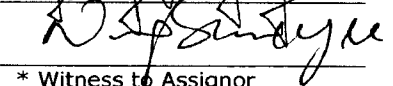
is desirous of acquiring our entire right, title and interest in and to said invention and the Letters Patent to be obtained therefor,

Now, therefore, in consideration of the payment by Assignee to Assignor of a sum corresponding to One Dollar (\$1.00), and for other good and valuable consideration, the receipt of which is hereby acknowledged, Assignor, intending to be legally bound, hereby sells, assigns and transfers to Assignee, its successors and assigns, the full and exclusive right, title and interest in and to said invention, all applications for Letters Patent for said invention, including all divisions, continuations, and continuations-in-part thereof, all rights to claim priority based thereon, and all Letters Patent, including reissues, to be obtained therefor, including any and all foreign patent rights in this invention corresponding thereto.

Assignor hereby warrants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor agrees it shall be legally bound, upon request of the Assignee or its successors or assigns or a legal representative thereof, to supply all information and evidence of which the Assignor has knowledge or possession, relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention in the United States of America and foreign countries in the name of the Assignee, and to execute all instruments proper to carry out the intent of this instrument.

In witness whereof, this Assignment is executed on the day indicated below.

	Typed or Printed Name	Signature	Date
SIGNATURE	<b>YEUNG, Wing Yiu</b>		14.06.2010
	<i>WONG, Shuk Yee</i>		14 Jun 2010
	* Witness to Assignor	* Witness to Assignor	